

CloudDC SuperServer SYS-121C-TN2R

Key Applications

Web Server, Firewall Application, Data Center Optimized, Value IaaS, Cloud Computing, Compact Server, DNS & Gateway Servers, Firewall Application, CDN, Edge Nodes,

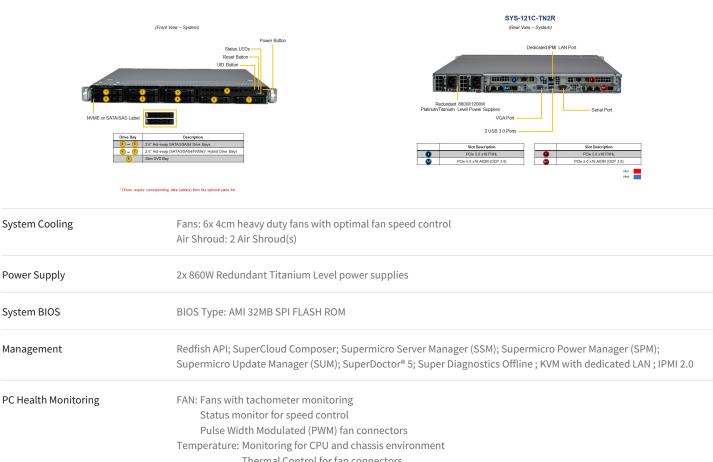
Key Features

- Dual sockets E (LGA-4677) 5th and 4th Gen Intel[®] Xeon[®] Scalable processors;
- + 16 DIMMs up to 4TB 3DS ECC DDR5-5600: RDIMM;
- 2 PCIe 5.0 x16 FHHL; 2 PCIe 5.0 x4 NVMe M.2;
- Dual AIOM (OCP 3.0) slots with NCSI for networking, 1 dedicated IPMI LAN;
- + 8x 2.5" hot-swap SATA/SAS4 w/ 2x hybrid NVME drive bays;
- 1 VGA, 1 COM, 2 USB 3.0 (rear);



• I VGA, I COM, 2 05B 5.0	(tear),
Form Factor	1U Rackmount
	Enclosure: 437 x 43 x 597mm (17.2" x 1.7" x 23.5")
	Package: 605 x 197 x 822mm (23.8" x 7.8" x 32.4")
Processor	Dual Socket E (LGA-4677)
	5th Gen Intel® Xeon®/4th Gen Intel® Xeon® Scalable processors
	Up to 32C/64T; Up to 82.5MB Cache per CPU
GPU	Max GPU Count: Up to 2 single-width GPU(s)
	Supported GPU: Intel PCIe: Intel Data Center GPU Flex 140
	NVIDIA PCIe: A2,L4
System Memory	Slot Count: 16 DIMM slots
	Max Memory (1DPC): Up to 4TB 5600MT/s ECC DDR5 RDIMM
Drive Bays	8x 2.5" hot-swap NVMe/SATA/SAS drive bays (2x 2.5" NVMe hybrid)(Storage drives require additional cables from
	the optional parts list.)
	2x PCIe 5.0 x4 (*VROC is required)
	M-Key, 2280
Expansion Slots	2 PCIe 5.0 x16 FHHL slot(s)
On-Board Devices	NVMe: NVMe; RAID 0/1/5/10 support (*VROC is required)
	SATA: SATA3 (6Gbps) via Intel [®] C741; RAID 0/1/5/10 support
	Chipset: Intel® C741
	Network Connectivity:
	with Advanced IO Module, AIOM (OCP 3.0 NIC, refer to AIOM Network Card(s) under Optional Parts List for options)
	Note: High TDP 200-400G NICs have support conditions due to thermal requirements.
	IPMI: Support for Intelligent Platform Management Interface v.2.0
	IPMI 2.0 with virtual media over LAN and KVM-over-LAN support
Input / Output	LAN: 1 Dedicated IPMI LAN port
	USB: 2 USB 3.0 port(s) (2 rear)
	Video: 1 VGA port(s)
	Serial Port: 1 COM Port(s) (1 rear)





	Thermal Control for fan connectors
	CPU: Monitors for CPU Cores, Chipset Voltages, Memory.
	8 Phase-switching voltage regulator
Dimensions and Weight	Height: 1.7" (43 mm)
	Width: 17.2" (437 mm)
	Depth: 23.5" (597 mm)
	Gross Weight: 40 lbs (18.1 kg)
	Net Weight: 25 lbs (11.3 kg)
	Packaging: 7.8" (H) x 23.8" (W) x 32.4" (D)
	Available Color: Black front & silver body
Operating Environment	Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F)
	Non-operating Temperature: -40°C to 60°C (-40°F to 140°F)
	Operating Relative Humidity: 8% to 90% (non-condensing)
	Non-operating Relative Humidity: 5% to 95% (non-condensing)
Motherboard	Super X13DDW-A
Chassis	CSE-LB13TS-R0AWNP2